



Thick Film Resistor Networks Single-In-Line, Molded SIP; 01, 03, 05 Schematics 6, 8, 9 or 10 Pin "A" Profile and 6, 8 or 10 Pin "C" Profile



FEATURES

- 0.195" [4.95mm] "A" or 0.350" [8.89mm] "C" maximum seated height
- · Highly stable thick film
- Low temperature coefficient (- 55°C to + 125°C) ± 100ppm/°C
- Rugged, molded case construction •
- Reduces total assembly costs •
- Compatible with automatic insertion equipment and reduces PC • board space
- Wide resistance range
- Available in tube pack or side-by-side pack

STANDARD ELECTRICAL SPECIFICATIONS							
MODEL/ SCHEMATIC	PROFILE	RESISTOR POWER RATING Max. @ 70°C* W	RESISTANCE RANGE Ω	STANDARD TOLERANCE ±%	TEMPERATURE COEFFICIENT (- 55°C to + 125°C) ppm/°C	TCR TRACKING* (- 55°C to + 125°C) ppm/°C	OPERATING VOLTAGE Max. VDC
MSP01	A C	0.20 0.25	10 - 2.2M	2 Standard (1, 5, 10, 20)**	± 100	± 50ppm/°C	100
MSP03	A C	0.30 0.40	10 - 2.2M	2 Standard (1, 5, 10, 20)**	± 100	± 50ppm/°C	100
MSP05	A C	0.20 0.25	10 - 2.2M	± 2 Standard (± 5%)**	± 100	± 150ppm/°C	100

* Tighter tracking available
** Tolerances in brackets available on request

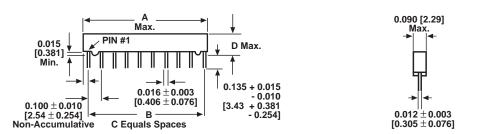
TECHNICAL SPECIFICATIONS			
PARAMETER	UNIT	MSP SERIES	
Package Power Rating (Maximum at + 25°C and + 70°C		See Derating Curves	
Voltage Coefficient of Resistance	V _{eff}	< 50ppm typical	
Dielectric Strength	VAC	200	
Isolation Resistance (03 Schematic)	Ω	> 100M	
Operating Temperature Range	°C	- 55 to + 125	
Storage Temperature Range	°C	- 55 to + 150	

MECHANICAL SPECIFICATIONS				
Marking Resistance to Solvents:	Permanency testing per MIL-STD-202, Method 215.			
Solderability:	Per MIL-STD-202, Method 208E, RMA flux.			
Body:	Molded epoxy.			
Terminals:	Copper alloy, tin-lead plated.			
Weight:	MSP06A = 0.4 gram MSP06C = 0.7 gram MSP08A = 0.5 gram MSP08C = 0.9 gram MSP09A = .55 gram MSP10C = 1.1 gram MSP10A = 0.6 gram MSP10C = 1.1 gram			



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DIMENSIONS in inches [millimeters]



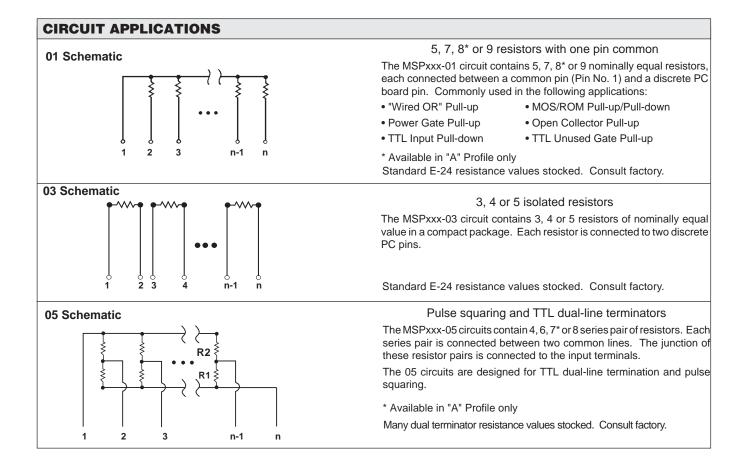
MODEL	A (Max.)	В	С	D (Max.)	
MSP06	0.590 [14.99]	0.500 [12.70]	5	MOD:::: A 0.405 [4.05]	
MSP08	0.790 [20.07]	0.700 [17.78]	7	MSPxxA = 0.195 [4.95] MSPxxC = 0.350 [8.89]	
MSP10	0.990 [25.15]	0.900 [22.86]	9		
MSP09	0.890 [22.61]	0.800 [20.32]	8	0.195 [4.95] ONLY	

ORDER	ING INFORMAT	ΓΙΟΝ			
01 Schem	natic				
MSP	08	А	01	101	G
MODEL	NUMBER OF	PACKAGE CODE	SCHEMATIC	RESISTANCE VALUE	TOLERANCE
		A =0.195" [4.95mm] Heig 0.100" [2.54mm] Lead C =0.350" [8.89mm] Heig 0.100" [2.54mm] Lead	l Spacing ht	First 2 digits (3 for "F" tolerance) are significant figures. Last digit specifies number of zeros to follow.	$F = \pm 1\%$ $G = \pm 2\%$ $J = \pm 5\%$
03 Schem	natic				
MSP	06	A	03	102	G
MODEL	NUMBER OF	PACKAGE CODE	SCHEMATIC	RESISTANCE VALUE	TOLERANCE
	PINS	A =0.195" [4.95mm] He 0.100" [2.54mm] Lea C =0.350" [8.89mm] He 0.100" [2.54mm] Lea	ad Spacing ight	First 2 digits (3 for "F" tolerance) are significant figures. Last digit specifies number of zeros to follow.	$F = \pm 1\%$ $G = \pm 2\%$ $J = \pm 5\%$
05 Schem					
MODEL NUMBER OF PACKAG		A PACKAGE CODE SCI).195" [4.95mm] Height	05 221 HEMATIC RESISTAN VALUE R		G TOLERANCE
0.100" [2.54mm] Lead Spacing First two digits are significant figures G=			$\begin{array}{l} G=\pm2\%\\ J=\pm5\% \end{array}$		
EXAMPLE:		EXAMPLE:		EXAMPLE:	
MSP08A-01-101G = A molded single-in- line thick film resistor network with 8 pins on 0.100" [2.54mm] centers, 0.195" [4.95mm] maximum seated height, 01 Schematic, resistance value of 100 ohm and a tolerance of $\pm 2\%$.		8 pins line thick film resis " on 0.100" [2.54mn] , 01 [4.95mm] maximu	m seated height, 03 ance value of 1000 ohm	MSP06A-05-221/331G = A molded single-in- line thick film resistor network with 6 pins on 0.100" [2.54mm] centers, 0.195" [4.95mm] maximum seated height, 05 Schematic with resistances of R1 = 220 ohm and R2 = 330 ohm and a tolerance $\pm 2\%$.	

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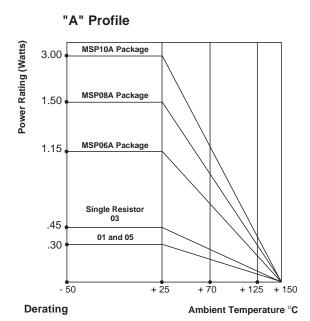


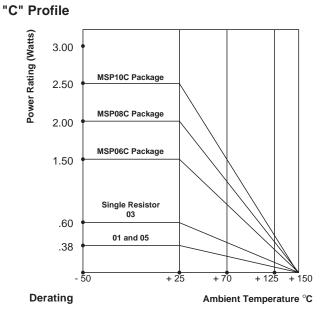


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MSP

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"A" PROFILE + 70°C PACKAGE RATINGS				
MSP10A	1.25 watts			
MSP09A	1.12 watts			
MSP08A	1.00 watts			
MSP06A	0.75 watts			

"C" PROFILE + 70°C PACKAGE RATINGS				
MSP10C	1.60 watts			
MSP08C	1.30 watts			
MSP06C	1.00 watts			
I				

Higher power ratings available. Contact factory.

PERFORMANCE				
TEST	CONDITIONS	MAX. ΔR (Typical Test Lots)		
Power Conditioning	1.5 x rated power, applied 1.5 hours "ON" and 0.5 hour "OFF" for 100 hours \pm 4 hours at + 25°C ambient temperature	± 0.50% ΔR		
Thermal Shock	5 cycles between - 65°C and + 125°C	± 0.50% ∆R		
Short Time Overload	2.5 x rated working voltage 5 seconds	± 0.25% ∆R		
Low Temperature Operation	45 minutes at full rated working voltage at - 65°C	± 0.25% ∆R		
Moisture Resistance	240 hours with humidity ranging from 80% RH to 98% RH	± 0.50% ∆R		
Resistance to Soldering Heat	Leads immersed in + 260°C solder to within 1/16" of device body for 10 seconds	\pm 0.25% ΔR		
Shock	Total of 18 shocks at 100 G's	± 0.25% ∆R		
Vibration	12 hours at maximum of 20 G's between 10 and 2,000 $\ensuremath{\text{Hz}}$	± 0.25% ∆R		
Load Life	1000 hours at + 70°C, rated power applied 1.5 hours "ON", 0.5 hour "OFF" for full 1,000 hour period. Derated according to the curve.	± 1.00% ΔR		
Terminal Strength	4.5 pound pull for 30 seconds	± 0.25% ΔR		
Insulation Resistance	10,000 Megohm (minimum)	_		
Dielectric Withstanding Voltage		_		